

HT1330 3 1/2 Digit Timer + Watch

Features

- A real time watch
- A 20-hour adjustable range setting count-down timer
- 20-minute count-up display cycle time
- 20 hours of count-up time maximum
- Auto recycle or manual reset the count-down timer by bonding option
- Hours and minutes are set independently
- Real time display in timer mode

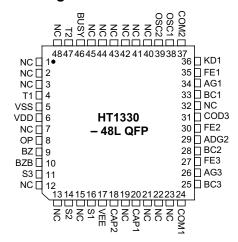
- 5-minute/10-minute pre-alarm
- DC output and piezo output
- An internal voltage doubler
- Busy flag output high in timer counting
- 3 1/2 digit LCD display
- 32768Hz crystal oscillator
- Single 1.5V battery operation
- 48L-pin QFP package

General Description

The HT1330 is a CMOS fabricated LSI chip designed to drive a standard three and 1/2 digit biplexed LCD for a count-up/down timer in watch applications. The watch and timer are based on a 32768Hz quartz crystal oscillator. The maximum count-down time is 20 hours with an accuracy of 1 second. The maximum count-up period is 20 hours, but the LCD will normally display a maximum period of 19 minutes and 59 seconds. If the user presses switch "S2", the total count-up time in hours and minutes will be displayed. In the count-up/down mode, the real time can be seen by pressing switch "S1" and return to the count-up/down mode by releasing "S1".

Once the count-down is finished, the timer can either automatically recycle the preset time or manually reset the desired time depending on the selected bonding-pad option. The forecast alarm generates 4 alarm sounds at 10 minutes before set time and 8 alarm sounds at 5 minutes before set time. The HT1330 can be used as a parking timer, an alarm timer, a pill box timer, a kitchen timer, a sports timer, etc.

Pin Assignment





Pad Assignment

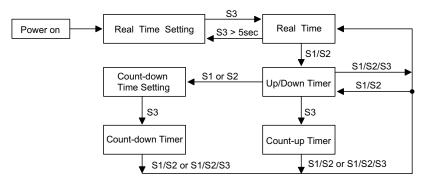
Pad Coordinates

T 3		• • •
	nit:	mı

		BZB					0	VDD			SSV			1			1			
S3	1	29	28				유 27	ŏ 26				크 24	73 23		Pad No.	X	Y	Pad No.	X	Y
S2	2												22	BUSY	1	-62.7	58.7	16	27.3	-58.7
															2	-62.7	48.7	17	37.3	-58.7
S1	3														3	-62.7	30.1	18	47.3	-58.7
VEE	4														4	-62.7	17.2	19	58.3	-58.7
CAP2	5						1								5	-62.7	7.3	20	62.7	-38.8
							1	0,0)	•						6	-62.7	-18.7	21	62.7	-23.7
							·								7	-62.7	-58.7	22	62.7	48.6
CAP1	6														8	-52.7	-58.7	23	62.7	58.7
													21	OSC2	9	-42.7	-58.7	24	43.8	58.7
															10	-32.7	-58.7	25	33.8	58.7
													20	OSC1	11	-22.7	-58.7	26	5.8	58.7
															12	-12.7	-58.7	27	-4.3	58.7
COM1	7	8	9	10	11	12	13	14	15	16	17	18	19		13	-2.7	-58.7	28	-38.6	58.7
		всз	AG3	FE3	BC2	ADG2	FE2	COD3	вс1	AG1	FE1	8	COM2		14	7.3	-58.7	29	-48.6	58.7
						2		ω					N		15	17.3	-58.7			

Chip size: $119 \times 112 \text{ (mil)}^2$

Operational Sequence



Note: S1 for Hour setting

S2 for Minute setting

S3 to Start/Stop the timer

S3>5 seconds into the real time setting mode

S1/S2 to reset the timer to the initial state (0:00)

S1/S2/S3 to return to the real time mode

^{*} The IC substrate should be connected to VDD in the PCB layout artwork.



Pin/Pad Description

11 1 S3 I Input to start/stop the timer 14 2 S2 I Input for minute setting 16 3 S1 I Input for hour setting 17 4 VEE — Negative voltage supply for LCD display 18 5 CAP2 O For voltage doubling capacitor 20 6 CAP1 O For voltage doubling capacitor 24 7 COM1 O Common 1 drive 25 8 BC3 O Segment drive 26 9 AG3 O Segment drive 26 9 AG3 O Segment drive 27 10 FE3 O Segment drive 28 11 BC2 O Segment drive 29 12 ADG2 O Segment drive 30 13 FE2 O Segment drive 31 14 COD3 O Segment drive <	Pin No.	Pad No.	Pad Name	I/O	Description
16	11	1	S3	I	Input to start/stop the timer
17 4 VEE — Negative voltage supply for LCD display 18 5 CAP2 O For voltage doubling capacitor 20 6 CAP1 O For voltage doubling capacitor 24 7 COM1 O Common 1 drive 25 8 BC3 O Segment drive 26 9 AG3 O Segment drive 27 10 FE3 O Segment drive 28 11 BC2 O Segment drive 29 12 ADG2 O Segment drive 30 13 FE2 O Segment drive 31 14 COD3 O Segment drive 33 15 BC1 O Segment drive 34 16 AG1 O Segment drive 35 17 FE1 O Segment drive 36 18 KD1 O Segment drive 37 19 COM2 O Common 2 drive 38 20 OSC1 I Oscillator input 39 21	14	2	S2	I	Input for minute setting
18 5 CAP2 O For voltage doubling capacitor 20 6 CAP1 O For voltage doubling capacitor 24 7 COM1 O Common 1 drive 25 8 BC3 O Segment drive 26 9 AG3 O Segment drive 27 10 FE3 O Segment drive 28 11 BC2 O Segment drive 30 13 FE2 O Segment drive 30 13 FE2 O Segment drive 31 14 COD3 O Segment drive 33 15 BC1 O Segment drive 34 16 AG1 O Segment drive 35 17 FE1 O Segment drive 36 18 KD1 O Segment drive 37 19 COM2 O Common 2 drive 38 20 <	16	3	S1	I	Input for hour setting
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46 22 BUSY O Timer busy flag, active high 47 23 T2 I/O Chip test pin 4 24 T1 I/O Fast-test control pin 5 25 VSS — Negative power supply 6 26 VDD — Positive power supply 8 27 OP I Option pin for countdown recycle	38	20	OSC1	I	Oscillator input
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4 24 T1 I/O Fast-test control pin 5 25 VSS — Negative power supply 6 26 VDD — Positive power supply 8 27 OP I Option pin for countdown recycle	46	22	BUSY	О	Timer busy flag, active high
5 25 VSS — Negative power supply 6 26 VDD — Positive power supply 8 27 OP I Option pin for countdown recycle	47	23	T2	I/O	Chip test pin
6 26 VDD — Positive power supply 8 27 OP I Option pin for countdown recycle	4	24	T1	I/O	Fast-test control pin
8 27 OP I Option pin for countdown recycle	5	25	VSS		Negative power supply
	6	26	VDD	_	Positive power supply
9 28 BZ O Piezo drive	8	27	OP	I	Option pin for countdown recycle
	9	28	BZ	О	Piezo drive
10 29 BZB O Piezo drive	10	29	BZB	О	Piezo drive



Absolute Maximum Rating

Supply Voltage0.3V to 5V	Storage Temperature–50°C to 125°C
Input Voltage V_{SS} -0.3V to V_{DD} +0.3V	Operating Temperature0°C to 70°C

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

Electric Characteristics

Ta=25°C

Symbol	Downerston	Test	Conditions	Min.	Тур.	Max.	Unit
	Parameter	V_{DD}	Conditions				
V_{DD}	Supply Voltage	1.5V	_	1.25	1.50	1.70	V
I_{DD}	Operating Current	1.5V	fosc=32768Hz No load	_	_	2	μA
$V_{\rm EE}$	Display Voltage	1.25~1.7V	_	-1.2	-1.5	-1.7	V
I_{IN}	Switch Input Current	1.5V	V _{IN} =VDD	5	_	65	μΑ
V_{STR}	Osc Starting Voltage	_	Within 3 secs	1.35	_	_	V
Δf/f	Frequency Stability	1.25~1.7V	_		_	10	PPM
I_{OHA}	Alarm Output Drive Current	1.5V	V _{OH} =1.35V	-480	_	_	μΑ
$f_{ m OUT}$	Alarm Output Frequency	1.5V	_	_	4096	_	Hz
I_{OHF}	Busy Flag Output Drive Current	1.5V	V _{OH} =1.35V	-480	_	_	μA

Functional Description

When power is turned on, all the LCD segments are illuminated to display "18:88" and the alarm sounds 2 seconds.

For fast-test, hold the "TP1" pin high and the minute digit will be increased every second.

In the count-down mode, when the time has gone past the set time and the alarm is stopped, the set time will remain at its current state or be reset to 0:00 depending on the bonding of the "OPT" pin to VDD.

In the timer mode, while the timer is counting, the actual time can be displayed by pressing "S1". Once "S1" is released, the count-down time will

be shown instead.

In the count-up mode, the LCD display is normally in minutes and seconds where the maximum count-up period is 20 minutes. If "S2" is pressed, the LCD display will revert to hours and minutes and the maximum count-up time will turn out to be 20 hours.

The timer alarm will sound during the count-down process as listed below:

4 sounds are generated at 10 minutes before the set time is up.

 $8\ sounds$ are generated at $5\ minutes$ before the set time is up.



Once the set time is reached, the alarm will sound 60 seconds unless it is stopped by users (by pressing S3), in which case the preset time of the timer will remain unchanged or at 0:00 depending on the status of the option pin.

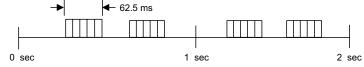
Pressing any one of the inputs $(S1 \ or \ S2 \ or \ S3)$ will stop the alarm during the period for which the alarm is sounding.

At 0:00 in the timer mode, the alarm will sound when S1 and S2 are simultaneously depressed. This is for the alarm test only.

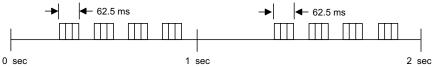
After the device is powered on, the alarm will sound two seconds and all segments on the LCD display panel be illuminated.

Output Waveform

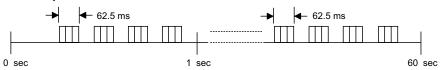
10 minutes before set time is up



5 minutes before set time is up



Time is up

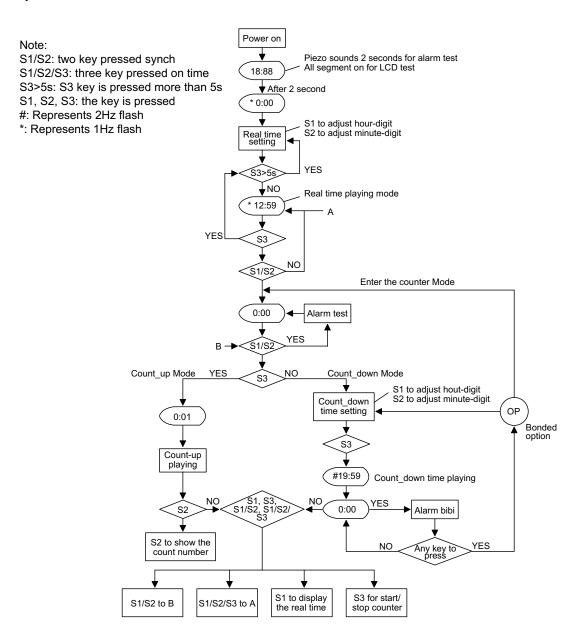


Timer busy flag output



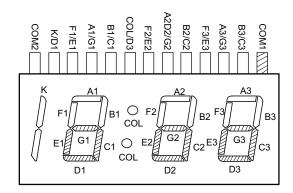


Operational FlowChart

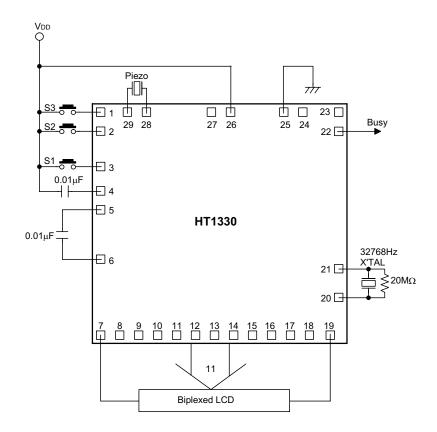




LCD Format



Application Circuits





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